

PRODUCT: TFT TOUCH MODULE

MODULE NO.: WKS50WV004-WCT

SUPPLIER: WKS Technology Co., LTD

DATE: Sep 8, 2017

SPECIFICATION

Revision: 0.1

WKS50WV004-WCT

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY
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REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2017-05-08	First release	Preliminary
0.1	2019-09-08	Change the position of the PCB hole	P5

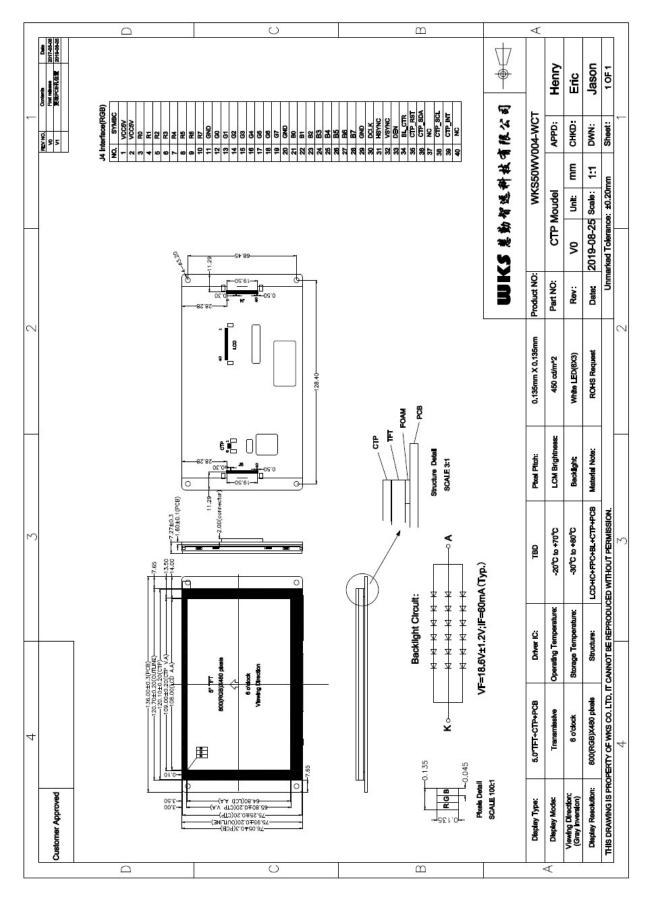
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1. GENERAL INFORMATION

Item of general information		Contents	Unit	
LCD Display Size (Diagonal)		5.0	inch	
Module Structure	LCD L	Display + CTP Touch + PCB	-	
LCD Display Type		TFT/TRANSMISSIVE	-	
LCD Display Mode		Normally White	-	
Recommended Viewing Direction		12	o'clock	
Gray inversion Direction		6	o'clock	
Module size $(W \times H \times T)$		136.00×76.05×7.27		
Active area (W×H)		mm		
Number of pixels (Resolution)		800RGB×480	pixel	
Pixel pitch (W×H)		0.135×0.135	mm	
Color Pixel Arrangement		RGB Stripe	-	
LCD Driver IC		-	-	
	LCD	RGB interface	-	
Module Interface Type	CTP	I2C interface	-	
Module Input voltage	5.0V		V	
Module Power consumption	-		mW	
Color Numbers		-		
Backlight Type		White LED	-	

2, EXTERNAL DIMENSIONS



3, ABSOLUTE MAXIMUM RATINGS

WKS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-20	70	${}^{\!$
Storage temperature	Tst	-30	80	$^{\circ}\!C$
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings means the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

4. ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

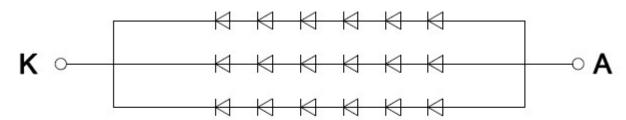
Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit
PCB operating voltage	VCC5V	-	5.0	-	V
LCD I/O operating voltage	VDD	2.3	3.3	3.6	V
Input voltage 'H' level	VIH	0.7*VDD	-	VDD	V
Input voltage 'L' level	VIL	VSS	-	0.3*VDD	V
Output voltage 'H' level	VOH	VDD-0.4	-	VDD	V
Output voltage 'L' level	VOL	VSS	-	VSS+0.4	V

5. BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward Voltage	Vf	17.4	18.6	19.8	V	Note1
Forward Current	If	-	60	-	mA	-
Number of LED	-	-	6*3=18	-	Piece	-
LED Connection mode	P/S	-	Serial/Parallel	-	-	-
Lifetime of LED	-	-	10000	-	hour	Note2

Note:

- ➤ Note1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and If=60mA.
- Note2: The LED lifetime define as the estimated time to 50% degradation of initial luminous. The LED lifetime could be decreased if operating If is lager than 60mA.
- ➤ Backlight control via the BL CTR pin or PWM signal.
- > Backlight circuit:



 $VF=18.6V\pm1.2V;IF=60mA(Typ.)$



Item of CTP characteristics	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	800 × 480	pixel	-
Surface Hardness	6H	-	-
Transparency	≥82%	-	-
Driver IC	GT5688	-	-
Interface Type	I2C	-	-
Support Points	5	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

7, ELECTRO-OPTICAL CHARACTERISTICS

Item o electro-op character	otical	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0.0	-	20	-	ms	FIG 1.	4
Contrast I	Ratio	CR	$\theta=0$ $\varnothing=0$	-	350	-	-	FIG 2.	1
Luminance un	iformity	<i>SWHITE</i>	Ta=25°C	_	80	-	%	<i>FIG 2</i> .	3
Surface Lum	inance	Lv	- W - Z - C	-	450	-	cd/m2	<i>FIG 2</i> .	2
	White	White x	_	-	0.317	-	_	FIG 2.	5
	wniie	White y		_	0.324	-			
	Red	Red x		_	0.633	_			
CIE(x, y)	кеа	Red y	$\theta=0$	_	0.341	_			
chromaticity	<i>C</i>	Green x	$\mathcal{Q}=0$ $Ta=25^{\circ}C$	-	0.324	-			
	Green	Green y	14 23 0	-	0.551	-			
	D.I	Blue x		-	0.153	-			
	Blue	Blue y		-	0.143	-			
	Ø=90(1	2 o'clock)		-	50	-	deg		
Viewing	Viewing Ø=270(6 o'clo		CD > 10	-	60	-	deg	EIC 2	
angle range	Ø=0(3	o'clock)	<i>CR</i> ≥ 10	-	65	-	deg	FIG 3.	6
	Ø=180 ₀	(9 o'clock)		-	65	-	deg		
NTSC ratio		-	-		50		%		-

Note 1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance $(\delta WHITE)$ is determined by measuring



luminance at each test position 1 through 9, and then dividing the maximum luminance of 9 points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

 $\delta \text{WHITE} = \frac{Minimum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}{Maximum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

Note 5. CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

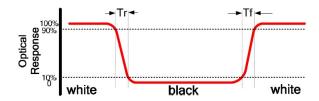




FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity,

CIE(x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

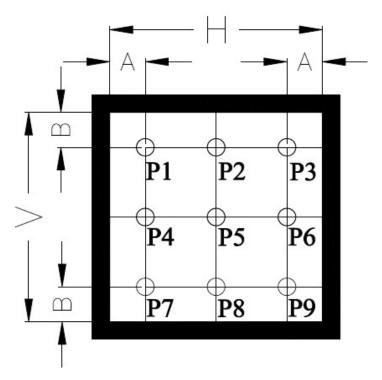
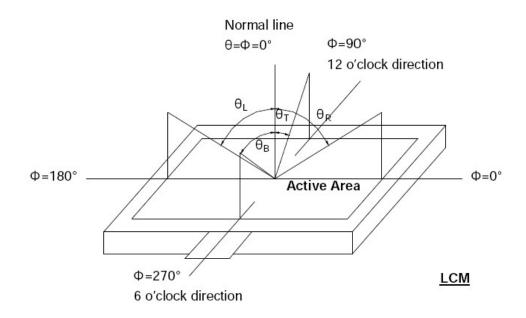


FIG.3. The definition of viewing angle





8. INTERFACE DESCRIPTION

NO.	Symbol	I/O	DESCRIPTION
1~2	VCC5V	Power supply	Module Power supply (5V Typ.)
3~10	R0~R7	I	8bit digital Red data input(R0:LSB; R7:MSB)
11	GND	Power supply	Power ground
12~19	G0~G7	I	8bit digital Green data input(G0:LSB; G7:MSB)
20	GND	Power supply	Power ground
21~28	B0~B7	I	8bit digital Blue data input(B0:LSB; B7:MSB)
29	GND	Power supply	Power ground
30	DCLK	I	Clock signal.
31	HSYNC	I	Horizontal Sync input.
32	VSYNC	I	Vertical Sync input.
33	DEN	I	Data input Enable.
34	BL_CTR	I	Backlight control pin
35	CTP_RST	I	CTP external reset signal, Low is active
36	CTP_SDA	I/O	CTP I2C data input and output
37	NC	-	No connection
38	CTP_SCL	I	CTP I2C clock input
39	CTP_INT	I	CTP External interrupt to the host
40	NC	-	No connection

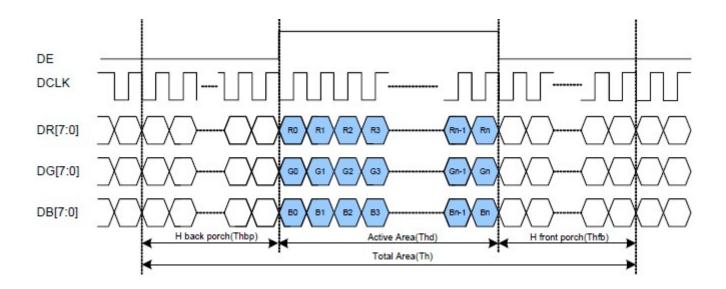
Application Note:

1. For RGB565 Input Format: R3~R7, G2~G7, B3~B7 be used.

2. For RGB666 Input Format: R2~R7, G2~G7, B2~B7 be used.

9, INPUT TIMING

RGB Interface Data Format



RGB Interface Input Timing Table

Danam at an	Sumb al		Value		Unit
Parameter	Symbol	Min.	Тур.	Max.	- Unii
DCLK frequency@ Frame rate=60Hz	DCLK	-	30	50	MHz
Horizontal display area	thd		800		DCLK
1 Horizontal Line	th	-	928	-	DCLK
HSYNC pulse width	thpw	1	48	-	DCLK
HSYNC Back Porch(Blanking)	thb	-	88	-	DCLK
HSYNC Front Porch	thfp	-	40	-	DCLK
Vertical display area	tvd		480		Н
VSYNC period time	tv	-	525	-	Н
VSYNC pulse width	tvpw	-	3	-	Н
VSYNC Back Porch(Blanking)	tvb	-	32	-	Н
VSYNC Front Porch	tvfp	-	13	-	Н



10 RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition
1	High Temperature Storage	80°C/120 hours
2	Low Temperature Storage	-30°C/120 hours
3	High Temperature Operating	70°C/120 hours
4	Low Temperature Operating	-20°C/120 hours
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- ➤ Air bubble in the LCD;
- > Sealleak;
- ➤ Non-display;
- Missing segments;
- ➤ Glass crack;
- Current is twice higher than initial value.

B, Remark:

- The test samples should be applied to only one test item.
- ➤ Sample size for each test item is 5~10pcs.
- Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



11, INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

11.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

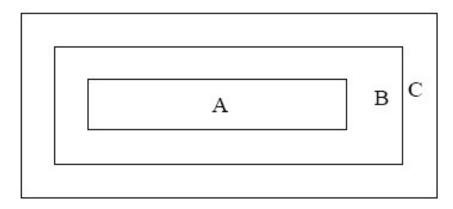
Minor defect: AQL 1.5

11.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40W$ light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature $20\sim25$ ° Cand normal humidity 60 $\pm15\%RH$)

11.3 Definition of Inspection Item.

A. Definition of inspection zone in LCD.





Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone $A + Zone B = minimum \ Viewing \ area)$

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig. 1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

B. Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under
	black pattern.
D. I. I.	Dots appear dark and unchanged in size in which LCD panel is displaying
Dark dot	under pure red, green, blue picture, or pure whiter picture.

11.4 Major Defect

Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

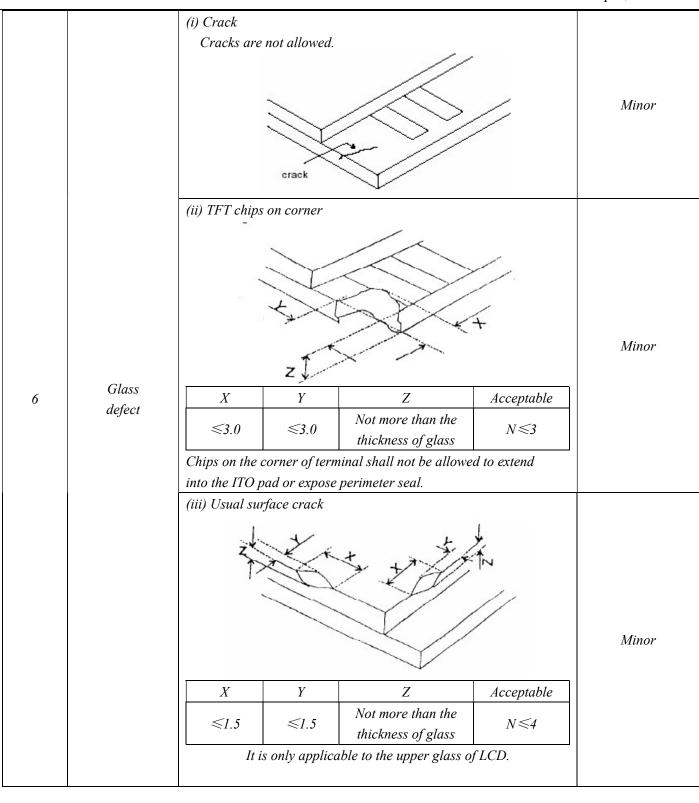
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5. Minor Defect

Item No.	Items to be	Inspection standard						Classification of defects
1	Bright dot /dark dot defect	Bright pixel do Dark pixel dot 2bright dots adjace 2dark dots adjace Total bright and dots Note: Minimum dista	cent dark	~7" 1 4 0 0 5	Acceptate A+B 7~10.1" 2 4 0 0 6	>10.1" 3 4 0 0 7	C Acceptable	Minor
	Dot defect y x	Pixel dots' function material and other r Zone Size(mm)	is normal, bı	ut bright udged b Acc A	t dots cai	used by foreig defect of 5.2	gn	
2		$ \begin{array}{c c} & \phi \leqslant 0.2 \\ \hline & 0.2 < \phi \leqslant 0.5 \\ \hline & \phi > 0.5 \end{array} $	Acceptable 4 0	e Acce	eptable 5 0	Acceptable 6 0	Acceptable	Minor
	$\Phi = (x+y)/2$	Note: 1. Minimum distance 2. The quantity of de						
3	Linear defect	Zone		Асс	eptable (
		Size (mm)			+B			
		Length Width Ignore W≤0.05	4.3"~7" Acceptable		210.1"	>10.1" Acceptable	<i>C</i>	Minor
		L≤5.0 0.05 < W≤0.1	4		5	6	Acceptable	
		L>5.0 W>0.1	0		0	0	le	

	100	CIT MOD			7007 77 C1	, crsto.		Sep 0, 2017
		5.4.1 Pola						
		(i) Shiftin						
		dimension						
		1 ' '	mplete cov	ering of the vie	ewing area du	e to shifting is	not	
		allowed.						
		5.4.2 Dirt						
		Dirt which						
		5.4.3 Pola						
		Zone			Acceptable	Qty		
					A+B	I		
		Size(mm)		4.3"~7"	7~10.1"	>10.1"	С	
		Φ :	<i>≤</i> 0.2	Acceptable	Acceptable	Acceptable	Acc	
		0.2 <	<i>Φ</i> ≤0.5	4	5	6	Acceptable	
4	Polarizer	Φ	>0.5	0	0	0	ible	Minor
	defect	5.4.4 Pol	arizer scr	atch				minor
		(i) If the i	polarizer :	scratch can b	e seen after	cover assemi	bling	
		1 ' ' '		condition, ji	v		_	
				scratch can		•	•	
		condition						
		Zone Acceptable Qty						
				A+B				
		Size (mm	1)		A⊤D			
		Length	Width	<i>4.3</i> "∼7"	7~10.1"	>10.1"	С	
		Ignore	W≤0.05	Acceptable	Acceptable	Acceptable	Ac	
		1.0 <l< td=""><td>0.05 <</td><td>4</td><td>5</td><td>6</td><td>Ассері</td><td></td></l<>	0.05 <	4	5	6	Ассері	
		≤5.0	<i>W</i> ≤0.20	,	3		otable	
		L>5.0	W > 0.2	0	0	0	е	
	MURA	Using						
	MUKA	Using						
5								Minor
			Minor					
	H/I : /D1 1							
	White/Black							
	dot (MURA)	0.13						





Item No.	Items to be inspected	Inspection Standard	Classification of defects			
1	Difference in Spec.	Not allowable	Major			
2	Pattern peeling	No substrate pattern peeling and floating	Major			
		No soldering missing	Major			
3	Soldering defects	No soldering bridge	Major			
		No cold soldering	Minor			
4	Resist flaw on PCB	Visible copper foil (Φ 0.5 mm or more) on substrate pattern is not allowed	Minor			
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major			
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor			
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor			
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed Φ 0.2mm)	Minor			
9	Stain	No stain to spoil cosmetic badly	Minor			
10	Plate discoloring	No plate fading, rusting and discoloring	Minor			
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor			
		b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor			
	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.				
11	3. Chips	(3/2) H ≥h ≥(1/2) H \$\int_{h} \hat{\tau}\$H	Minor			
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mm. The diameter of solder ball $d \le 0.15$ mm.	Minor			
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor			
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major			